

**SPECIFICATION AMENDMENTS**

Please replace the original first paragraph one on page 1 of the specification with the paragraph below:

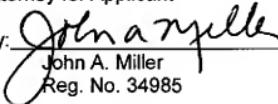
The invention relates to a positioning apparatus and to a positioning method for transferring at least one electronic component, in particular a chip, from a first flat support to at least one predetermined location on a second flat support which extends parallel to the first support, comprising an ejection device for removing the component from the first support by means of an ejection movement, according to the ~~preambles of Claims 1 and 17.~~

Please delete the third full paragraph on page 3 of the original specification.

~~This object is achieved in terms of the apparatus by the features of Claim 1, and in terms of the method by features of claim 17.~~

Respectfully submitted,

MILLER IP GROUP, PLC  
Attorney for Applicant

By:   
John A. Miller  
Reg. No. 34985

Dated: 2/16/12  
42690 Woodward Ave., Ste. 200  
Bloomfield Hills, MI 48304  
Telephone: (248) 858-4200  
Facsimile: (248) 858-4201